

from numerous investigations on the phenomenon of LME are presented, and possible mechanisms and prerequisites for its occurrence are discussed. The influence of metallurgical, physical, and mechanical parameters on LME are reviewed in terms of the various mechanisms. An extensive summary and bibliography on LME of metals and alloys during soldering or industrial processing are also presented.

Chapter 10 by Hawthorne provides an in-depth review of irradiation embrittlement of common structural steels for service temperatures below 400°C. Irradiation embrittlement of ferritic steels, and the environmental and metallurgical variables which influence the irradiation response of alloys are described. Mechanical-property data and correlations for estimating radiation effects during reactor service are presented. Recent efforts to develop radiation-resistant structural steels and methods for restoring mechanical properties of irradiated materials are detailed.

The last chapter by Solomon describes metallurgical processes that result in weld defects or cracks: hot cracking of weld metal, reheat or stress-relief cracking of heat-affected zones (HAZ), weld sensitization, and cold or hydrogen cracking. A detailed discussion of solute distribution during solidification and its effect on weld structure identifies the factors that influence hot cracking. The influence of alloy composition, trace impurities, and welding conditions on susceptibility to weld defects is described in great detail.

This volume offers comprehensive coverage of topics involved in materials degradation. The scope and relevance of these subjects will provide impetus and guidance to materials scientists, engineers, and designers. The well-illustrated volume with its extensive background information, bibliography, and detailed discussions could serve as a source book for students and researchers in materials science. It should be a valuable addition to reference libraries.

*Reviewer: Omesh K. Chopra is a metallurgist in the Materials Science and Technology Division of Argonne National Laboratory.*

## Materials for Microlithography

**Edited by L.F. Thompson, C.G. Willson, and J.M.J. Frechet**

*(Volume 266 of ACS Symposium Series, American Chemical Society, 1984)*

This volume is a collection of papers given in a symposium at the American Chemical Society's Annual Meeting in St. Louis, MO in April 1984.

Conference proceedings often convey a rather fragmented picture of their field. This volume achieves unusual consistency

due partly to three excellent introductory chapters by Everhart (Limits of Lithography), by Broers (Fundamentals), and by Bowden (Resist Materials). The other papers fall into two groups: the first concerns the fundamental radiation chemistry of electron beam, x-ray, or deep UV materials; the second deals directly with resist materials and their applications.

A brief perusal of the papers will show that coverage of the field of microlithographic materials is fairly comprehensive and that the volume title is justified.

*Reviewer: Arnost Reiser is chairman of the Department of Imaging Sciences of the Polytechnic Institute of New York, Brooklyn, NY.*

## New Frontiers in Rare Earth Science and Applications, Volume I

**Edited by G. Xu and J. Xiao**  
*(Science Press, Beijing and Academic Press, New York, 1985)*

*New Frontiers in Rare Earth Science and Application* contains the proceedings of the International Conference on Rare Earth Development and Applications held in Beijing, China, September 10-14, 1985. The editors, Drs. Xu and Xiao, are professors at Peking University and Beijing University of Iron and Steel Technology, respectively. Volume I includes approximately 170 extended abstracts of invited and contributed papers by several internationally recognized authorities on the rare earths and by numerous workers from the People's Republic of China.

In addition to plenary lectures, the volume includes a mixture of reports on theoretical, experimental, and applied topics. The People's Republic reportedly has the world's largest reserves of rare earths, and the rapid expansion of interest in rare earth technology suggests that the development of this resource is being actively pursued. Surprisingly large sections are devoted to geochemistry, extraction, and analytical chemistry. Approximately one fourth of the papers are related to bio-inorganic and organometallic chemistry, but only ten papers were presented on the chemistry and physics of solids. Sections on quantum chemistry and spectroscopy, catalysis, and environmental chemistry are also included.

Volume II was not available for review, but abstracts on important topics such as luminescence, hydrogen storage, and magnetism are included in the table of contents. Lengthy sections on applications in steels, alloys, and ceramics also appear in the second volume along with a series of reports on the effects of rare earths in crop production, nitrogen fixation, and other agricultural applications. The abstracts generally provide enough information to be of

technical value, but they are probably most useful as a guide to current directions of rare earth research, particularly in the People's Republic of China.

*Reviewer: J.M. Haschke, a member of the research staff at Rockwell International, has been interested in the solid-state chemistry of rare earth and actinide compounds throughout his career.*

## Glass IV

**Edited by M. Tomozawa and R.H. Doremus**

*(Volume 26 of Treatise on Materials Science and Technology, Academic Press, 1985)*

*Glass IV* is the most recent volume in a series that began with the publication of *Glass I* in 1977. This volume contains five chapters in different areas in glass, science, and technology.

In the first chapter, J.M. Aitken (IBM Corporation) and E.A. Irene (University of North Carolina) review the use of SiO<sub>2</sub> films in semiconductor devices. The aim of the review, according to the authors, is to give materials scientists working outside the electronics industry some insight into the role of glass films in modern micro-electronic devices. They describe the preparation method of the films, physicochemical characterization of the films, and electrical properties of the films.

In the second chapter, G.C. Wicks summarizes the progress in the program on the solidification of nuclear waste in glass. He starts his description with waste disposal strategy and then explains the vitrification process and waste-glass performance.

The third chapter, written by R.E. Loehman, covers almost every field of the science of oxynitride glasses, which attracts much interest because of their mechanical properties. This chapter consists of seven sections: introduction, glass synthesis, compositional system, properties, crystallization, structure, and applications.

Heavy-metal fluoride glasses, good candidates for an optical material that accesses the mid-IR region, are described in the fourth chapter by M.G. Drexhage (Rome Air Development Center). Beginning with the history of fluoride glasses, he covers almost all areas in the science of these glasses.

The final chapter on viscoelastic analysis of stresses in composites was written by G.W. Scherer (Corning Glass Works) and S.M. Rekhson (General Electric Company). This chapter explains and quantifies the influence of relaxation phenomena on the stresses in composites such as seals. The description includes numerical formulae for the analysis and then the comparison with measured results and calculated stress followed for different geometric shapes of the composites.

*continued*